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CONFIRMATION NO. 4487

<b>SERIAL NUMBER</b> 10/500,494	<b>FILING OR 371(c) DATE</b> 12/27/2004 <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2812	<b>ATTORNEY DOCKET NO.</b> 9907-007
<b>APPLICANTS</b> Hyung-Sang Park, Seoul, KOREA, REPUBLIC OF; Sang-Won Kang, Daejeon, KOREA, REPUBLIC OF;				
<b>** CONTINUING DATA *****</b> This application is a 371 of PCT/KR02/02468 12/28/2002				
<b>** FOREIGN APPLICATIONS *****</b> REPUBLIC OF KOREA 10-2001-0086955 12/28/2001				
<b>** SMALL ENTITY **</b>				
Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged _____ Examiner's Signature _____ Initials _____		<b>STATE OR COUNTRY</b> KOREA, REPUBLIC OF	<b>SHEETS DRAWING</b> 2	<b>TOTAL CLAIMS</b> 20
<b>INDEPENDENT CLAIMS</b> 2				
<b>ADDRESS</b> 20575				
<b>TITLE</b> Method of forming copper interconnections for semiconductor integrated circuits on a substrate				
<b>FILING FEE RECEIVED</b> 735	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit _____	